



**Spec No.: DS-70-99-0019** Effective Date: 05/23/2014

Revision: G

**LITE-ON DCC** 

**RELEASE** 

BNS-OD-FC001/A4



#### **DESCRIPTION**

#### 1.1 Features

- 6 Pin DIP photocoupler, Triac driver output
- High input-output isolation voltage

Viso = 5,000Vrms

- High repetitive peak off-state voltage V<sub>DRM</sub>: Min. 400 V.
- High critical rate of rise of off-state voltage dV/dt: Min.1000V / μs
- Dual-in-line package:
  - MOC3020, MOC3021, MOC3022, MOC3023
- Wide lead spacing package:
  - MOC3020M, MOC3021M, MOC3022M, MOC3023M
- Surface mounting package: MOC3020S, MOC3021S, MOC3022S, MOC3023S
- Tape and reel packaging:
  - MOC3020S-TA, MOC3021S-TA, MOC3022S-TA, MOC3023S-TA MOC3020S-TA1, MOC3021S-TA1, MOC3022S-TA1, MOC3023S-TA1
- Safety approval
  - \* UL approved (No. E113898)
  - \* TUV approved (No. R9653630)
  - \* CSA approved (No. CA91533-1)
  - \* VDE approved (No. 40015248)
  - \* CQC approved (No.CQC11001061921-2)
- RoHS Compliance
  - All materials be used in device are followed EU RoHS directive (No.2002/95/EC).
- ESD pass HBM 8000V/MM2000V
- MSL class1

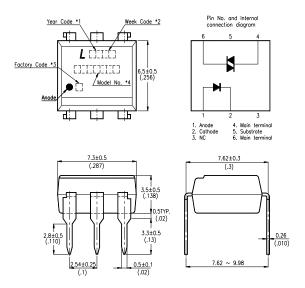
#### 1.2 Applications

- Motor Controls.
- Solid state relays
- For triggering high power thyristor and triac
- Household use equipment

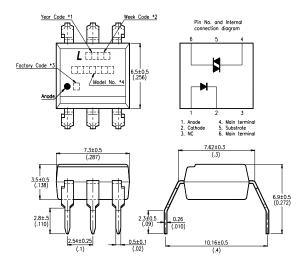


#### 2. PACKAGE DIMENSIONS

#### 2.1 MOC3020, MOC3021, MOC3022, MOC3023:



#### 2.2 MOC3020M, MOC3021M, MOC3022M, MOC3023M:

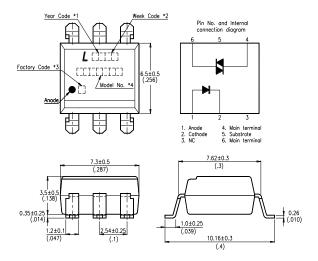


#### Notes:

- 1. Year date code.
- 2. 2-digit work week.
- 3. Factory identification mark shall be marked (Y: Thailand, W: China-CZ, X: China-TJ).
- 4. Model No.MOC3020, MOC3021, MOC3022, MOC3023



#### 2.3 MOC3020S, MOC3021S, MOC3022S, MOC3023S:



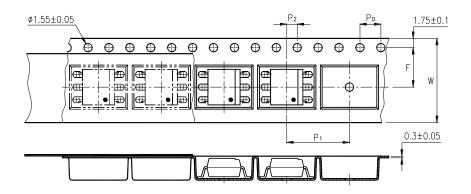
#### Notes:

- 1. Year date code.
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- 3. Factory identification mark shall be marked (Y: Thailand, W: China-CZ, X: China-TJ).
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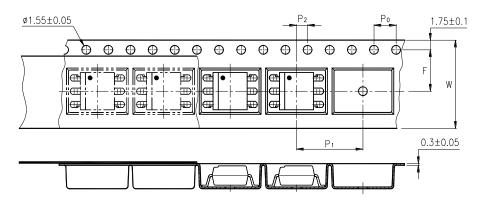


#### 3. TAPING DIMENSIONS

#### 3.1 MOC3020S-TA, MOC3021S-TA, MOC3022S-TA, MOC3023S-TA:



#### 3.2 MOC3020S-TA1, MOC3021S-TA1, MOC3022S-TA1, MOC3023S-TA1:



| Description                            | Symbol         | Dimension in mm (inch) |
|----------------------------------------|----------------|------------------------|
| Tape wide                              | W              | 16±0.3 (0.63)          |
| Pitch of sprocket holes                | P <sub>0</sub> | 4±0.1 (0.15)           |
| Distance of compartment                | F              | 7.5±0.1 (0.295)        |
| Distance of compartment                | P <sub>2</sub> | 2±0.1 (0.079)          |
| Distance of compartment to compartment | P <sub>1</sub> | 12±0.1 (0.472)         |



#### **RATING AND CHARACTERISTICS**

#### 4.1 Absolute Maximum Ratings at Ta=25°C

|                           | Parameter                         | Symbol           | Rating             | Unit             |  |
|---------------------------|-----------------------------------|------------------|--------------------|------------------|--|
|                           | Forward Current                   | I <sub>F</sub>   | 50                 | mA               |  |
| Input                     | Reverse Voltage                   | $V_R$            | 6                  | V                |  |
|                           | Power Dissipation                 | $P_D$            | 70                 | mW               |  |
|                           | Off-State Output Terminal Voltage | $V_{DRM}$        | 400                | V                |  |
| Output                    | Peak Repetitive Surge Current     |                  | 4                  | ^                |  |
|                           | (PW=100µs, 120pps)                | I <sub>TSM</sub> | 1                  | А                |  |
|                           | Collector Power Dissipation       | Pc               | 300                | mW               |  |
| Total Power Di            | ssipation                         | P <sub>tot</sub> | 330                | mW               |  |
| *1 Isolation Vo           | ltage                             | V <sub>iso</sub> | 5,000              | V <sub>rms</sub> |  |
| Ambient O                 | perating Temperature Range        | T <sub>A</sub>   | -40 ~ <b>+</b> 100 | °C               |  |
| Storage Temperature Range |                                   | $T_{stg}$        | -55 ~ +150         | °C               |  |
| *2 Soldering Temperature  |                                   | TL               | 260                | °C               |  |

#### \*1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.
- \*2. For 10 Seconds



#### 4.2 ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

|          | PARAMETER                                                                  |         | SYMBOL           | MIN. | TYP. | MAX. | UNIT | CONDITIONS                    |
|----------|----------------------------------------------------------------------------|---------|------------------|------|------|------|------|-------------------------------|
| IN IDLIT | Forward Voltage                                                            |         | VF               | _    | 1.15 | 1.5  | V    | IF=20mA                       |
| INPUT    | Reverse Current                                                            |         | IR               | _    | _    | 10   | μА   | VR=6V                         |
|          | *1 Peak Blocking Current, Either Direction                                 |         | I <sub>DRM</sub> | _    | 10   | 100  | nA   | V <sub>DRM</sub> = 400V       |
| OUTPUT   | Peak On-State Voltage, Either Direction                                    |         | $V_{TM}$         | _    | 1.7  | 3    | V    | I <sub>TM</sub> =100 mA Peak  |
|          | *2 Critical rate of Rise of Off-State Voltage                              |         | dv/dt            | 1000 | _    | _    | V/μs |                               |
| COUPLED  | *3 Led Trigger Current, Current Required to Latch Output, Either Direction | MOC3020 | l <sub>FT</sub>  | _    | 15   | 30   | mA   | Main Terminal<br>Voltage = 3V |
|          |                                                                            | MOC3021 |                  | _    | 8    | 15   |      |                               |
|          |                                                                            | MOC3022 |                  | _    | _    | 10   |      |                               |
|          |                                                                            | MOC3023 |                  | _    | _    | 5    |      |                               |
|          | Holding Current, Either Direction                                          |         | l <sub>Η</sub>   | _    | 250  | _    | μΑ   |                               |

<sup>\*1</sup> Test voltage must be applied within dv/dt rating.

<sup>\*2</sup> This is static dv/dt. Commutating dv/dt is a function of the load-driving thyristor(s) only.

<sup>\*3</sup> All devices are guaranteed to trigger at an  $I_F$  value less than or equal to max  $I_{FT}$ . Therefore, recommended operating  $I_F$  lies between max  $I_{FT}$ , 30 mA for MOC3020, 15 mA for MOC3021, 10 mA for MOC3022, 5 mA for MOC3023, and absolute max  $I_F$  (50mA)



#### 5. CHARACTERISTICS CURVES

Fig.1 Forward Current vs.

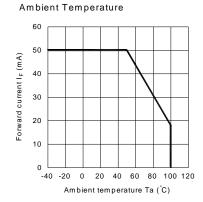


Fig.3 Minimum Trigger Current vs. Ambient Temperature

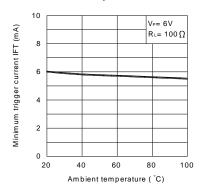


Fig.5 On-state Voltage vs. Ambient Temperature

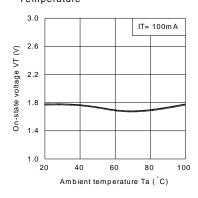


Fig.2 On-state Current vs. Ambient Temperature

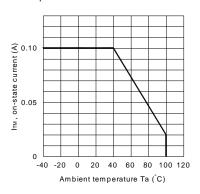


Fig.4 Forward Current vs. Forward Voltage

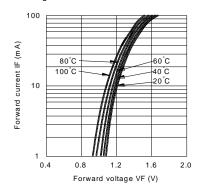


Fig.6 Holding Current vs.

Ambient Temperature

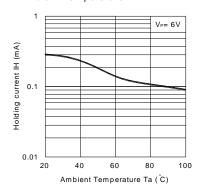




Fig.7 Repetitive Peak Off-state Current vs. Temperature

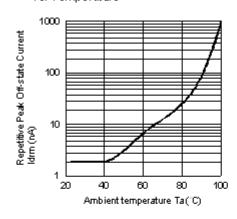
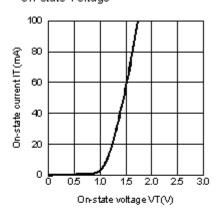
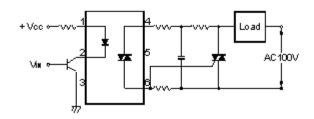


Fig.8 On-state Current vs. On-state Voltage



Basic Operation Circuit
Medium/High Power Triac Drive Circuit



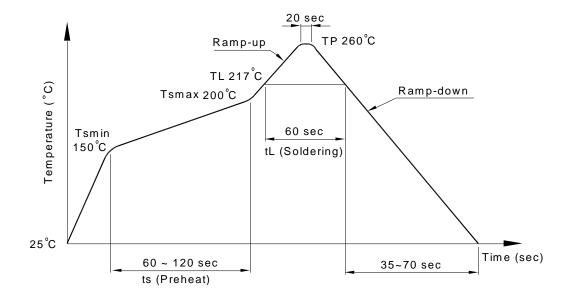


#### 6. TEMPERATURE PROFILE OF SOLDERING

6.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

| Profile item                           | Conditions     |  |
|----------------------------------------|----------------|--|
| Preheat                                |                |  |
| - Temperature Min (T <sub>Smin</sub> ) | 150°C          |  |
| - Temperature Max (T <sub>Smax</sub> ) | 200°C          |  |
| - Time (min to max) (ts)               | 90±30 sec      |  |
| Soldering zone                         |                |  |
| - Temperature (T <sub>L</sub> )        | 217°C          |  |
| - Time (t <sub>L</sub> )               | 60 sec         |  |
| Peak Temperature (T <sub>P</sub> )     | 260°C          |  |
| Ramp-up rate                           | 3°C / sec max. |  |
| Ramp-down rate                         | 3~6°C / sec    |  |





#### 6.2 Wave soldering (JEDEC22A111 compliant)

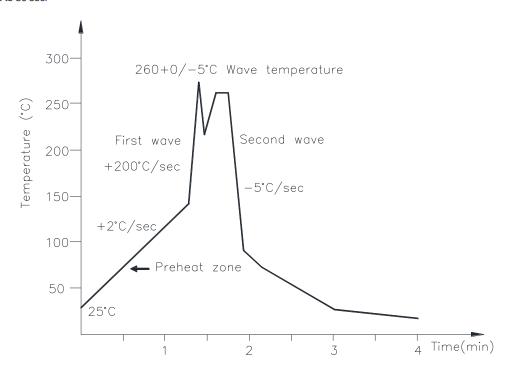
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C

Time: 10 sec.

Preheat temperature:25 to 140°C

Preheat time: 30 to 80 sec.



#### 6.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

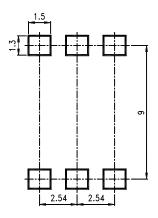
Temperature: 380+0/-5°C

Time: 3 sec max.

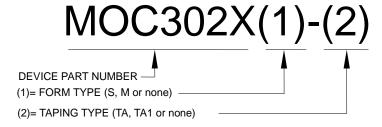


#### 7. RRECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)

Unit: mm



#### 8. NAMING RULE



#### 9. Notes:

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.

Part No : MOC3020 THRU MOC3023 SERIES BNC-OD-C131/A4